1 Introduction

The LM3450A evaluation board is designed to provide an AC to LED solution for a 30W LED load. Specifically, it takes an AC mains input and converts it to a constant current output of 700mA for a series string of 1 to 13 LEDs (maximum LED stack voltage of 45V). There are two assembly versions designed to operate from two different nominal AC input voltages, $120V_{AC}$ or $230V_{AC}$.

The board employs a two stage design with an LM3450A flyback primary stage and an LM3409HV secondary stage. The LM3450A provides an isolated 50V regulated output voltage and a power factor corrected input current. The LM3409HV uses the 50V flyback output as its input and provides a constant current of 700mA to the LED load. This two stage design provides excellent line and load regulation as well as isolation. The board is comprised of two copper layers with components on both sides and an FR4 dielectric.

The two-stage design has several key advantages over a single stage design including:

- No 120Hz LED current ripple
- Better dimming performance at low dimming levels.
- Better line disturbance rejection
- Better efficiency using small LED stack voltages

2 Specifications

120V$_{AC}$ 30W Version

- Input Voltage Range: $V_{IN} = 90V_{AC} - 135V_{AC}$
- Regulated Flyback Output Voltage: $V_{OUT} = 50V$
- Maximum LED Stack Voltage: $V_{LED} < 45V$
- Regulated LED Current: $I_{LED} = 700mA$

230V$_{AC}$ 30W Version

- Input Voltage Range: $V_{IN} = 180V_{AC} - 265V_{AC}$
- Regulated Flyback Output Voltage: $V_{OUT} = 50V$
- Maximum LED Stack Voltage: $V_{LED} < 45V$
- Regulated LED Current: $I_{LED} = 700mA$
Figure 1. Schematic
3 Typical Performance

Figure 2. 120V, 30W Version
Efficiency vs. Output Power

Figure 3. 230V, 30W Version
Efficiency vs. Output Power

Figure 4. 120V, 30W Version
Power Factor vs. Output Power

Figure 5. 230V, 30W Version
Power Factor vs. Output Power
4  Conducted EMI Performance

Figure 6. 120V, 30W Conducted EMI Peak Scan
Line and Neutral - CISPR/FCC Class B Quasi Peak and Average Limits

Figure 7. 230V, 30W Conducted EMI Peak Scan
Line and Neutral - CISPR/FCC Class B Quasi Peak and Average Limits

5  THD / Harmonic Performance

Figure 8. 120V, 30W THD Measurements
EN 61000-3 Class C Limits
THD = 6.27% ; Fundamental = 316mA

Figure 9. 230V, 30W THD Measurements
EN 61000-3 Class C Limits
THD = 8.96% ; Fundamental = 167mA
## LM3450A Pin Descriptions

<table>
<thead>
<tr>
<th>Pin</th>
<th>Name</th>
<th>Description</th>
<th>Application Information</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>V&lt;sub&gt;REF&lt;/sub&gt;</td>
<td>3V Reference</td>
<td>Reference Output: Connect directly to V&lt;sub&gt;ADJ&lt;/sub&gt;, or to resistor divider feeding V&lt;sub&gt;ADJ&lt;/sub&gt; and to necessary external circuits.</td>
</tr>
<tr>
<td>2</td>
<td>V&lt;sub&gt;ADJ&lt;/sub&gt;</td>
<td>Analog Adjust</td>
<td>Analog Dim and Phase Dimming Range Input: Connect directly to V&lt;sub&gt;REF&lt;/sub&gt; to force standard 70% phase dimming range. Connect to resistor divider from V&lt;sub&gt;REF&lt;/sub&gt; to extend usable range of some phase dimmers or for analog dimming. Connect to GND for low power mode.</td>
</tr>
<tr>
<td>3</td>
<td>FLT2</td>
<td>Filter 2</td>
<td>Ramp Comparator Input: Connect a series resistor from FLT1 capacitor and a capacitor to GND to establish second filter pole.</td>
</tr>
<tr>
<td>4</td>
<td>FLT1</td>
<td>Filter 1</td>
<td>Angle Decoder Output: Connect a series resistor to a capacitor to GND to establish first filter pole.</td>
</tr>
<tr>
<td>5</td>
<td>DIM</td>
<td>500 Hz PWM Output</td>
<td>Open Drain PWM Dim Output: Connect to dimming input of output stage LED driver (directly or with isolation) to provide decoded dimming command.</td>
</tr>
<tr>
<td>6</td>
<td>V&lt;sub&gt;AC&lt;/sub&gt;</td>
<td>Sampled Rectified Line</td>
<td>Multiplier and Angle Decoder Input: Connect to resistor divider from rectified AC line.</td>
</tr>
<tr>
<td>7</td>
<td>COMP</td>
<td>Compensation</td>
<td>Error Amplifier Output and PWM Comparator Input: Connect a capacitor to GND to set the compensation.</td>
</tr>
<tr>
<td>8</td>
<td>FB</td>
<td>Feedback</td>
<td>Error Amplifier Inverting Input: Connect to output voltage via resistor divider to control PFC voltage loop for non-isolated designs. Connect to a 5.11kΩ resistor to GND for isolated designs (bypasses error amplifier). Also includes over-voltage protection and shutdown modes.</td>
</tr>
<tr>
<td>9</td>
<td>I&lt;sub&gt;SEN&lt;/sub&gt;</td>
<td>Input Current Sense</td>
<td>Input Current Sense Non-Inverting Input: Connect to diode bridge return and resistor to GND to sense input current for dynamic hold. Connect a 0.1µF capacitor and Schottky diode to GND, and a 0.22µF capacitor to HOLD.</td>
</tr>
<tr>
<td>10</td>
<td>GND</td>
<td>Power Ground</td>
<td>System Ground</td>
</tr>
<tr>
<td>11</td>
<td>CS</td>
<td>Current Sense</td>
<td>MosFET Current Sense Input: Connect to positive terminal of sense resistor in PFC MosFET source.</td>
</tr>
<tr>
<td>12</td>
<td>GATE</td>
<td>Gate Drive</td>
<td>Gate Drive Output: Connect to gate of main power MosFET for PFC. Gate Drive Output: Connect to gate of main power MosFET for PFC.</td>
</tr>
<tr>
<td>13</td>
<td>V&lt;sub&gt;CC&lt;/sub&gt;</td>
<td>Input Supply</td>
<td>Power Supply Input: Connect to primary bias supply. Connect a 0.1µF bypass capacitor to ground.</td>
</tr>
<tr>
<td>14</td>
<td>ZCD</td>
<td>Zero Crossing Detector</td>
<td>Demagnetization Sense Input: Connect a resistor to transformer/inductor winding to detect when all energy has been transferred.</td>
</tr>
<tr>
<td>15</td>
<td>HOLD</td>
<td>Dynamic Hold</td>
<td>Open Drain Dynamic Hold Input: Connect to holding resistor which is connected to source of passFET.</td>
</tr>
</tbody>
</table>
## LM3409HV Pin Descriptions

<table>
<thead>
<tr>
<th>Pin</th>
<th>Name</th>
<th>Description</th>
<th>Application Information</th>
</tr>
</thead>
<tbody>
<tr>
<td>16</td>
<td>BIAS</td>
<td>Pre-regulator Gate Bias</td>
<td>Pre-regulator Gate Bias Output: Connect to gate of passFET and to resistor to rectified AC (drain of passFET) to aid with startup.</td>
</tr>
</tbody>
</table>

### Pin Descriptions

<table>
<thead>
<tr>
<th>Pin</th>
<th>Name</th>
<th>Description</th>
<th>Application Information</th>
</tr>
</thead>
<tbody>
<tr>
<td>1</td>
<td>UVLO</td>
<td>Input Under Voltage Lock-out</td>
<td>Connect to a resistor divider from V&lt;sub&gt;IN&lt;/sub&gt;. UVLO threshold is 1.24V and hysteresis is provided by a 22µA current source.</td>
</tr>
<tr>
<td>2</td>
<td>I&lt;sub&gt;ADJ&lt;/sub&gt;</td>
<td>Analog LED Current Adjust</td>
<td>Apply a voltage between 0 - 1.24V, or connect a resistor from this pin to GND, to set the current sense threshold voltage.</td>
</tr>
<tr>
<td>3</td>
<td>EN</td>
<td>Logic Level Enable</td>
<td>Apply a voltage &gt;1.6V to enable device, a PWM signal to dim, or a voltage &lt;0.6V for low power shutdown.</td>
</tr>
<tr>
<td>4</td>
<td>COFF</td>
<td>Off-time programming</td>
<td>Connect an external resistor from V&lt;sub&gt;O&lt;/sub&gt; to this pin, and a capacitor from this pin to GND to set the off-time.</td>
</tr>
<tr>
<td>5</td>
<td>GND</td>
<td>Power Ground</td>
<td>Connect to the system ground.</td>
</tr>
<tr>
<td>6</td>
<td>PGATE</td>
<td>Gate Drive</td>
<td>Connect to the gate of the external PFET.</td>
</tr>
<tr>
<td>7</td>
<td>CSN</td>
<td>Negative Current Sense</td>
<td>Connect to the negative side of the sense resistor.</td>
</tr>
<tr>
<td>8</td>
<td>CSP</td>
<td>Positive Current Sense</td>
<td>Connect to the positive side of the sense resistor (also connected to V&lt;sub&gt;IN&lt;/sub&gt;).</td>
</tr>
<tr>
<td>9</td>
<td>V&lt;sub&gt;CC&lt;/sub&gt;</td>
<td>V&lt;sub&gt;IN&lt;/sub&gt;-referenced Linear Regulator Output</td>
<td>Connect at least a 1 µF ceramic capacitor from this pin to CSN. The regulator provides power for P-FET drive.</td>
</tr>
<tr>
<td>10</td>
<td>V&lt;sub&gt;IN&lt;/sub&gt;</td>
<td>Input Voltage</td>
<td>Connect to the input voltage.</td>
</tr>
<tr>
<td></td>
<td>DAP</td>
<td>Thermal PAD on bottom of IC</td>
<td>Connect to pin 5 (GND). Place 4-6 vias from DAP to bottom layer GND plane.</td>
</tr>
</tbody>
</table>

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**LM3409HV Pin Descriptions**

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Figure 10. Simplified Evaluation Board Schematic
9 Design Information

The following section explains how to design using the LM3450A power factor controller and phase dimming decoder. Refer to AN-1953 LM3409HV Evaluation Board (SNVA390) for a detailed design procedure of the LM3409HV secondary stage and to the LM3450/A LED Drivers with Active Power Factor Correction & Phase Dimming Decoder (SNVAS681) data sheet for specific details regarding the function of the LM3450A device. All reference designators refer to the Simplified Evaluation Board Schematic. Note that parallel and series resistances are combined in one schematic symbol for simplification. To improve readability of this design document, each subsection is followed by a list of Definitions for new terms used in the calculations. Section 11, showing all components and connectors, is found at the end of this document as well as a Bill of Materials for each assembly version.

Figure 11. Two-Stage PFC LED Driver

9.1 1st Stage - CRM Flyback

The first stage of the evaluation board shown in Figure 11 is a critical conduction mode (CRM) flyback converter controlled with the LM3450A. CRM converters operate at the boundary of continuous conduction mode (CCM) and discontinuous conduction mode (DCM). CRM is implemented by turning on the main switching FET (Q3) until the primary current rises to a peak threshold. Q3 is then turned off and the current falls until a zero crossing is detected. At this point, Q3 is turned on and the cycle repeats.

In the CRM flyback PFC application, the rectified AC input is fed forward to the control loop, yielding a sinusoidal peak current threshold. This peak threshold creates a sinusoidal primary peak current envelope $I_{P\text{-pk}}$ as shown in Figure 12. The secondary peak current envelope $I_{S\text{-pk}}$ will simply be a scaled version of the primary according to the turns ratio of the transformer. Assuming good attenuation of the switching ripple via the EMI filter, the average input current $I_{in}(t)$, shown in red, can also be approximated as a sinusoid. Since the input current has the same shape and phase as the input voltage, high power factor (PF) can easily be achieved.
The input current shaping happens instantly in CRM due to the feed-forward mechanism; however, the converter must also regulate the flyback output voltage with a traditional feedback loop. This is accomplished with a narrow bandwidth error amplifier coupled with energy storage capacitance at the output to limit the twice line frequency ripple. The output of the error amplifier is multiplied with the scaled rectified AC voltage to achieve both input current shaping and output voltage regulation. Refer to the datasheet for a more detailed explanation of the power factor controller.

The LM3450A also has a phase decoder that interprets the phase dimming angle and maps it to a 500Hz PWM open-drain output at the DIM pin. This signal is directly connected to an opto-isolator to send across the isolation boundary to the second stage LED driver. In addition, the LM3450A provides a dynamic hold circuit to ensure that the holding current requirement is satisfied in forward phase dimmers. Refer to the datasheet for a more detailed explanation of the phase dimmer decoder.

9.2 2\textsuperscript{nd} Stage - Buck LED Driver

The second stage of the evaluation board is a buck LED driver controlled with the LM3409HV. The input to this stage is the flyback output voltage and the output is a regulated constant current of 700mA to a stack of <45V of LEDs. The LM3409HV is a hysteretic PFET controller using peak current detection and a constant off-timer to provide regulated LED current with a constant switching frequency ripple. Coupled with the flyback energy storage capacitance, the LM3409HV is able to remove all 120HZ ripple content from the LED output. The 500Hz PWM signal from the first stage is used as the dimming input to the LM3409HV. The output of the opto-isolator is connected directly to the EN pin of the LM3409HV to provide a PWM dimmed LED current according to the detected phase angle at the primary.

The LM3409HV design is not included in this document. Refer to AN-1953 for a detailed design procedure. The specifications for the second stage are:

- Nominal Input Voltage = 50V
- Regulated LED Current = 700mA
- Nominal LED Stack Voltage = 45V
- Switching Frequency at Nominal Input = 100kHz
- Inductor/LED Current Ripple = 115mA

9.3 CRM Flyback Converter

Operating Points
The AC mains voltage, at the line frequency $f_L$, is assumed to be perfectly sinusoidal and the diode bridge ideal. This yields a perfect rectified sinusoid at the input to the flyback. The input voltage $V_{in}(t)$ is defined in terms of the peak input voltage:

$$V_{in}(t) = V_{IN-PK} \times \left| \sin(2 \times \pi \times f_L \times t) \right|$$

$$V_{IN-PK} = V_{in} \times \sqrt{2}$$

(1)

The controller and the transformer are also assumed to be ideal. These assumptions yield a sinusoidal peak primary current envelope $I_{P-pk}(t)$ and peak secondary current envelope $I_{S-pk}(t)$ as shown in Figure 12. Both are defined in terms of the peak primary current:

$$I_{P-pk}(t) = I_{P-pk} \times \left| \sin(2 \times \pi \times f_L \times t) \right|$$

$$I_{S-pk}(t) = n \times I_{P-pk}(t)$$

(2)

The output voltage reflected to the primary is defined:

$$V_R = n \times V_{OUT}$$

(3)

CRM control yields a variable duty cycle over a single line cycle with a minimum occurring at the peak input voltage:

$$D(t) = \frac{V_R}{V_R + V_{IN-PK}(t)}$$

$$D_{MIN} = \frac{V_R}{V_R + V_{IN-PK}}$$

(4)

The resulting sinusoidal average input current $I_{in}(t)$, shown in Figure 12, is approximated as the average of each triangular current pulse during a switching period. The peak input current occurs at the peak primary current:

$$I_{IN-PK} = \frac{I_{P-pk} \times D(t)}{2}$$

$$I_{IN-PK} = \frac{I_{P-pk} \times D_{MIN}}{2}$$

(5)

**Turns Ratio**

The first thing to decide with an isolated design is the desired transformer turns ratio. This should be based on the specified output voltage and the maximum peak input voltage. Frequently the MosFET is already chosen for a design, given its cost and availability. With a desired MosFET voltage, the maximum reflected voltage at the primary is calculated:

$$V_{R-MAX} = \frac{2}{3} \times (V_{T-DES-MAX} - V_{IN-PK-MAX})$$

(6)

Generally, an integer turns ratio is selected to achieve a reflected voltage at or below the defined maximum:

$$n < \frac{V_{R-MAX}}{V_{OUT}}$$

(7)

**Switching MosFET**

The main switching MosFET (Q3) can be sized as desired; to block the maximum drain-to-source voltage, operate at the maximum RMS current, and dissipate the maximum power:

$$V_{T-MAX} = V_{IN-PK-MAX} + (1.5 \times V_R)$$

$$I_{T-PK-MAX} = I_{P-PK-MAX}$$

$$I_{T-RMS-MAX} = I_{P-PK-MAX} \times \sqrt{\frac{D_{MIN-PK-MAX}}{3}}$$

$$P_{T-MAX} = I_{T-RMS-MAX}^2 \times R_{OS-ON}$$

(8)
R30 || R31 = \frac{1.5V}{I_{\text{lim}}^2} \tag{9}

The parallel sense resistor combination (R30||R31) has to dissipate the maximum power:

\[ P_{R30||R31} = I_{T-\text{RMS-MAX}}^2 \times R30 || R31 \tag{10} \]

### Switching Diode

The main switching diode (D10) should be sized to block the maximum reverse voltage, operate at the maximum average current, and dissipate the maximum power:

\[ V_{RD-MAX} = V_{oUT} + \left( \frac{V_{IN-PK-MAX}}{n} \right) \]

\[ I_{D-MAX} = I_{IN-PK-MAX} \times 2 \]

\[ I_{D-PK-MAX} = I_{P-PK-MAX} \times 2 \]

\[ P_{D-MAX} = I_{D-MAX} \times V_{FD} \tag{11} \]

### Definitions

n – Primary to Secondary Turns Ratio

\( V_{OUT} \) – Regulated Output Voltage

\( V_{IN} \) – Nominal AC Input Voltage

\( V_{IN-PK} \) – Peak Input Voltage

\( V_{IN-PK-MAX} \) – Maximum Peak Input Voltage

\( I_{P-PK} \) – Peak Primary Current

\( I_{S-PK} \) – Peak Secondary Current

\( I_{IN-PK} \) – Peak Input Current

\( I_{LIM} \) – Peak Current Limit

\( D_{MIN} \) – Minimum Duty Cycle over Line Cycle

\( V_{R} \) – Output Voltage Reflected to Primary

\( V_{R-MAX} \) – Maximum Tolerable Reflected Voltage

\( V_{T-DES-MAX} \) – Maximum Tolerable MosFET Voltage

\( V_{T-MAX} \) – Maximum MosFET Blocking Voltage

\( I_{T-RMS-MAX} \) – Maximum MosFET RMS Current

\( I_{T-PK-MAX} \) – Maximum MosFET Peak Current

\( P_{T-MAX} \) – Maximum MosFET Power Dissipation

\( V_{RD-MAX} \) – Maximum Diode Blocking Voltage

\( I_{D-MAX} \) – Maximum Diode Average Current

\( I_{D-PK-MAX} \) – Maximum Diode Peak Current

\( P_{D-MAX} \) – Maximum Diode Power Dissipation

### 9.4 Transformer

**Primary Inductance**
The maximum peak input current, occurring at the minimum AC voltage peak, determines the necessary flyback transformer energy storage. As a general rule of thumb, the desired duty cycle at this worst-case operating point should be specified near 0.5 to limit large conduction losses associated with high voltage diodes. The maximum input current can be approximated by the maximum output power, expected converter efficiency, and minimum input voltage. Note that there is also a 0.85 multiplier to account for the fact that maximum power with a triac dimmer in-line is demanded at approximately 85% of the full sinusoidal voltage waveform. Given the desired duty cycle, the maximum peak input current and corresponding maximum peak primary current can be approximated:

\[
I_{IN \cdot MAX} = \frac{P_{OUT \cdot MAX}}{\eta \times 0.85 \times V_{IN \cdot MIN}}
\]

\[
I_{IN \cdot PK \cdot MAX} = I_{IN \cdot MAX} \times \sqrt{2}
\]

\[
I_{P \cdot PK \cdot MAX} = \frac{2 \times I_{IN \cdot PK \cdot MAX}}{D_{MIN \cdot MAX \cdot PK}}
\]

Using the calculated turns ratio and the desired minimum switching frequency, the minimum necessary primary inductance is calculated:

\[
L_{P \cdot MIN} > \frac{D_{MIN \cdot IN \cdot PK \cdot MAX}^2 \times V_{IN \cdot MIN}}{2 \times f_{SW \cdot MIN \cdot DES} \times I_{IN \cdot PK \cdot MAX}}
\]

### Switching Frequency Range

Given a primary inductance that meets the above constraint, the variable switching frequency has the following limits:

\[
f_{SW \cdot MAX} = \frac{V_{IN \cdot PK}}{L_P \times I_{P \cdot PK}}
\]

\[
f_{SW \cdot MIN} = \frac{V_{IN \cdot PK} \times V_R}{L_P \times I_{P \cdot PK} \times (V_R + V_{IN \cdot PK})}
\]

### Transformer Geometries and Materials

The length of the gap necessary for energy storage in the flyback transformer can be determined numerically; however, this can lead to non-standard designs. Instead, an appropriate \( A_L \) core value (160nH/turns^2 is a good standard value to start with) can be chosen that will imply the gap size. \( A_L \) is an industry standard used to define how much inductance, per turns squared, that a given core can provide. With the initial chosen \( A_L \) value, the number of turns on the primary and secondary are calculated:

\[
N_P = \frac{L_P}{A_L}
\]

\[
N_S = \frac{N_P}{n}
\]

Given the switching frequency range and the maximum output power, a core size can be chosen using the vendor’s specifications and recommendations. This choice can then be validated by calculating the maximum operating flux density given the core cross-sectional area of the chosen core.

\[
B_{MAX} = \frac{L_P \times I_{P \cdot PK \cdot MAX}}{N_P \times A_{E \cdot MAX}}
\]

With most common core materials, the maximum operating flux density should be set between 300mT and 3400mT. If the calculation is below this range, then \( A_L \) should be increased to the next standard value and the turns and maximum flux density calculations iterated. If the calculation is above this range, then \( A_L \) should be decreased to the next standard value and the turns and maximum flux density calculations iterated.

With the flux density appropriately set, the core material for the chosen core size can be determined using the vendor’s specifications and recommendations. Note that there are core materials that can tolerate higher flux densities; however, they are usually more expensive and not always practical for these designs.
The rest of the transformer design should be done with the aid of the manufacturer. There are calculated trade-offs between the different loss mechanisms and safety constraints that determine how well a transformer performs. This is an iterative process and can ultimately result in the choice of a new core or switching frequency range. The previous steps should reduce the number of iterations significantly but a good transformer manufacturer is invaluable for completion of the process.

**Definitions**

\( \eta \) – Expected converter efficiency  
\( P_{\text{OUT-MAX}} \) – Maximum Output Power  
\( V_{\text{IN-MIN}} \) – Minimum RMS AC Line Voltage  
\( V_{\text{IN-PK-MIN}} \) – Minimum Peak Input Voltage  
\( I_{\text{IN-PK-MAX}} \) – Maximum Peak Input Current  
\( I_{\text{P-PK-MAX}} \) – Maximum Peak Primary Current  
\( D_{\text{IN-PK-MAX}} \) – Duty Cycle at Maximum Peak Input Current  
\( L_{\text{P-MIN}} \) – Minimum Necessary Primary Inductance  
\( L_p \) – Chosen Primary Inductance  
\( f_{\text{SW-MIN-DES}} \) – Desired Minimum Switching Frequency  
\( f_{\text{SW-MIN}} \) – Minimum Switching Frequency  
\( f_{\text{SW-MAX}} \) – Maximum Switching Frequency  
\( N_p \) – Number of Primary Turns  
\( N_s \) – Number of Secondary Turns  
\( A_{E-MAX} \) – Core Cross-Sectional Area  
\( B_{\text{MAX}} \) – Maximum Operating Flux Density  
\( A_L \) – Transformer Core Figure of Merit

![Figure 13. Bias Circuitry](image)

### 9.5 Bias Supplies and Capacitances

**Bias Supplies**
The primary bias supply shown in Figure 13 enables instant turn-on through Q1 while providing an auxiliary winding for high efficiency steady state operation. The two bias paths are each connected to $V_{CC}$ through a diode (D8, D9) to ensure the higher of the two is providing $V_{CC}$ current. The LM3450A BIAS pin helps to ensure that the auxiliary winding is always providing $V_{CC}$ during normal operation.

Since there is optical isolation, a secondary bias supply is also desirable. This is accomplished with another auxiliary winding, diode (D4), and capacitance (C4, C5) which creates another flyback output that scales with the regulated output (similar to the auxiliary primary bias winding). To ensure secondary bias regulation is closely coupled to the regulated flyback output, the output winding is tapped to provide the secondary bias output.

It is also advantageous to linear regulate down to approximately 9V, from the 12V bias supplies, for every opto-isolator supply rail ($V_{POP1}$, $V_{OP1}$, $V_{OP2}$). This will stabilize the opto-isolator rail over the entire operating range, preventing noise coupling into COMP and the dimming input of the LM3409.

The primary and secondary bias outputs for both versions of the board are set to 12.5V at the nominal input voltage. The turns calculations (referred to the output) for the primary auxiliary winding and the tap point for the secondary winding are:

$$n_{\text{AUX}} = \frac{V_{\text{OUT}}}{V_{CC}}$$

$$N_A = \frac{N_S}{n_{\text{AUX}}}$$

(17)

The minimum primary bias supply capacitance is calculated, given a minimum $V_{CC}$ ripple specification, to keep $V_{CC}$ above UVLO at the worst-case current:

$$C44 = \frac{I_{CC}}{\Delta V_{CC} \times f_{L}}$$

(18)
Input Capacitance

The input capacitor of the flyback (C1), also called the PFC capacitor, has to be able to provide energy during the worst-case switching period at the peak of the AC input. C1 should be a high frequency, high stability capacitor (usually a metallized film capacitor, either polypropylene or polyester) with an AC rating equal to the maximum input voltage. C1 should also have a DC voltage rating exceeding the maximum peak input voltage + half of the peak to peak input voltage ripple specification. The minimum required input capacitance is calculated given the same ripple specification:

\[
C1 = \frac{L_p \times I_{p,PK,MAX}^2}{\left(\frac{V_{IN-PK-MIN} + \frac{\Delta v_{IN-PK}}{2}}{2}\right) - \left(\frac{V_{IN-PK-MIN} - \frac{\Delta v_{IN-PK}}{2}}{2}\right)^2}
\]  
(19)

Output Capacitance

Since the LM3450A is a power factor controller, C1 is minimized and the output capacitor (C11) serves as the main energy storage device. C11 should be a high quality electrolytic capacitor that can tolerate the large current pulses associated with CRM operation. The voltage rating should be at least 25% greater than the regulated output voltage and, given the desired voltage ripple, the minimum output capacitance is calculated:

\[
C11 = \frac{P_{OUT-MAX}}{2 \times \pi \times f_{2L} \times V_{OUT} \times \Delta v_{OUT}}
\]  
(20)

Definitions

\(\Delta v_{IN-PK}\) – Peak Input Voltage Switching Ripple  
\(\Delta v_{OUT}\) – Nominal Output Voltage Ripple  
\(\Delta v_{CC}\) – Nominal Primary Bias Ripple  
\(V_{CC}\) – Primary Bias Capacitance  
\(n_{AUX}\) – Output to Auxiliary Turns Ratio  
\(N_A\) – Number of Auxiliary Turns  
\(f_{2L}\) – Twice Line Frequency

Figure 14. Dynamic Hold Circuit with Thermal Protection
9.6 Hold Current

**Dynamic Hold**

The LM3450A regulates the minimum input current with a dynamic hold circuit to ensure the triac holding current requirement is satisfied. The regulated minimum current is set by choosing the sense resistor (R34||R36):

\[
I_{\text{IN-MIN-REG}} = \frac{200 \text{ mV}}{R34 \parallel R36}
\]  

(21)

The maximum possible holding current (usually occurs during transients when triac fires) is set by choosing the hold resistor (R12||R14||R15) between the source of the Q1 and HOLD:

\[
I_{\text{HOLD-MAX}} = \frac{V_{\text{CC}}}{R12 \parallel R14 \parallel R15 + 30 \Omega}
\]  

(22)

**PassFET**

The passFET (Q1) is used in its linear region to stand-off the line voltage from the LM3450A controller. Both the \(V_{\text{CC}}\) startup current and the triac holding current are conducted through the device. Since the holding current is far larger than the startup current and is dynamically adjusted every cycle, it will dominate the calculations. Given this, Q1 is chosen to block the maximum peak input voltage and conduct the maximum holding current. The surge handling capability of Q1 is also important and is evaluated by looking at the safe operating area (SOA) of the device.

Finally, Q1 needs to be able to dissipate the maximum power. Looking at an absolute worst-case condition for the Q1 (during open load where the converter draws near-zero power), extremely large power dissipation is required (many Watts). Designing for this case is unrealistic and costly. Instead, Figure 15 can be used to find the maximum \(I_{\text{IN-MIN-REG}}\) for the desired minimum output power level. The minimum output power is defined as the output power that causes the dynamic hold to force approximately 1W of power dissipation in Q1 (causing approximately 100°C rise in a DPAK). Below the minimum output power level, Q1 can reach temperatures exceeding 125°C, depending on the conduction angle, causing potential catastrophic failure. Figure 15 is only a general guideline based on experimental testing of this evaluation board. Each application will have a different passFET thermal characteristic, which suggests thermal protection of the passFET is usually necessary.

![Figure 15. Output Power Restrictions (without thermal protection)](image-url)
Thermal Protection

Using the previously mentioned design methodology, thermal protection is indeed necessary for the open load condition and for power levels below the specified operating range shown in Figure 15. The thermal protection circuit shown in Figure 14 will reduce the maximum holding current when the temperature rises too high, thus preventing catastrophic failure of Q1. Keep in mind that the thermal foldback does not prevent the circuit from operating, it simply reduces the amplitude of the dynamic hold. The only negative effect of the thermal protection is a possible reduction in contrast ratio, meaning the minimum attainable output current potentially increases as the dynamic hold level decreases.

The thermal protection is accomplished using a PNP transistor (Q11) and a resistor divider comprised of a fixed resistor (R45) and an NTC thermistor (R44). As Q1 heats up, R44 decreases causing the collector voltage of Q11 to decrease, effectively reducing the maximum attainable holding current. Placement of R44 is critical to ensure the best possible thermal coupling to Q1. The drain of Q1 will have the highest temperature rise but it is at a much higher voltage than the source where R44 is electrically connected. Because of this, the best placement for R44 is on the other side of the PCB, directly under the drain of Q1. The dielectric of the PCB provides adequate electrical insulation while yielding the best thermal coupling. Obviously, R44 placement in potted solutions is much more forgiving. A 10kΩ NTC is suggested for R44 and Q11 can be a basic PNP (i.e. MMBT3906). R45 has to be sized experimentally since the thermal coupling will vary with each PCB layout. A good starting point for R45 is 15kΩ.

Definitions

\( I_{IN-MIN-REG} \) – Regulated Minimum Input Current
\( I_{HOLD-MAX} \) – Maximum Hold Current

9.7 Dimming Decoder

Angle Sense

\( V_{AC} \) is a dual input for both the PFC multiplier and the angle decoder. The resistor divider (R26+R29, R32) should be sized according to the desired angle detect voltage \( V_{DET} \). A general rule of thumb is to set \( V_{DET} = V_{IN-PK}/x \) where \( x \) is a value between 4 and 7. R26+R29 should be chosen to be between 1MΩ and 2MΩ to limit power dissipation.

\[
R_{32} = \frac{356 \text{ mV} \times (\text{R26 + R29})}{V_{DET} - 356 \text{ mV}}
\]

(23)
Decoder Mapping

The mapping from the demodulated input (VAC pin of the LM3450A) to output (EN pin of the LM3409HV) is shown in Figure 17. Varying $V_{ADJ}$ will adjust the mapping as desired for the target dimmers. Keep in mind that the demodulated input angle is a function of the resistor divider at the $V_{AC}$ pin. This means that the input duty cycle can be shifted by changing $V_{DET}$ within the previously suggested range.

Filters

The filters (FLT1, FLT2) are chosen to provide the desired dimming transition response (how the light changes during dimmer movement). The filter frequency should be set between 2Hz and 10Hz for best operation (2Hz has a fade feeling, 10Hz is very snappy). The capacitors (C17, C18) can both be set to 1µF for all designs and given the filter frequencies, the resistors (R24, R25) are calculated:

$$R24 = \frac{1}{2 \pi f_{FLT2} C17}$$
$$R25 = \frac{1}{2 \pi f_{FLT1} C18}$$

Figure 17. Dimming Decoder Mapping

Opto-Isolator

A standard low cost opto-isolator (same type used for feedback of the output) is used to transfer the dimming command from DIM to the secondary. It needs to be driven with at least 1-2mA of current to obtain full 70:1 contrast ratio (more current creates faster edges). With $V_{POP2} = 9V$ and $R16 = 6.04k\Omega$, there is > 1mA of drive current. The output of the opto-isolator should be clamped to just above the dimming input threshold of the secondary driver. This is accomplished with a 1.8V Zener clamp (D22) at the EN pin of the LM3409HV on the evaluation boards. R71 needs to be large enough that the Zener clamp is activated whenever the LM3409HV EN pin should be high.

Definitions

$V_{DET}$ – Rectified AC Angle Detect Voltage

$f_{FLT1}$ – FLT1 frequency

$f_{FLT2}$ – FLT2 frequency
9.8 Voltage Control Loop

The CRM topology requires a narrow bandwidth voltage control loop to regulate the output voltage. This loop needs to be compensated to maintain stability over the desired operating range. The flyback topology is isolated, therefore the LM3450A internal error amplifier is bypassed and an external secondary side error amplifier is used instead. The control loop shown in Figure 18 is comprised of the converter control-to-output transfer function, the compensator transfer function, and all of the other gains in the loop.

The output voltage is sensed with a resistor divider (R81, R72) and regulated to 1.24V using an LMV431:

$$R81 = \frac{1.24V \times R72}{V_{OUT} - 1.24V}$$  \hspace{1cm} (25)

The converter control-to-output transfer function can be approximated as a single pole system:

$$G_{VC}(s) = \frac{1}{1 + \frac{s}{\omega_{P1}}}$$

$$\omega_{P1} = \frac{P_{OUT-MAX}}{V_{OUT}^2 \times C11}$$

$$G_{CD} = \frac{V_{OUT}}{I_{P-PK}}$$  \hspace{1cm} (26)

The feedback gain ($H_{FB}$) is unity due to the control implementation and the LM3450A device and external gains are defined:

$$G_{3450} = \frac{5k\Omega \times CTR \times K_V \times 0.55 \times \frac{1}{V} \times V_{IN-PK}}{(R30 \parallel R31) \times R70 \frac{R32}{R32 + (R26 + R29)}}$$

$$K_V = \frac{R32}{R32 + (R26 + R29)}$$  \hspace{1cm} (27)

A standard PI compensator is used on the secondary to stabilize the system. The error amplifier is implemented with an LMV431 and a series resistor (R77) and capacitor (C35) in the feedback path as shown in Figure 19. The output of the LMV431 is tied to the cathode of the opto photo-diode. A resistor (R70 = 2kΩ) from the anode of the photodiode to the bias rail provides the current path and ultimately the output voltage swing of the secondary error amplifier. The primary side of the opto is connected directly to COMP. With the 5kΩ internal pull-up resistor, the maximum current through the primary side of the opto will be 1mA. A higher frequency roll-off pole is placed on the primary in the form of a capacitor (C24) from COMP to GND. The resistor divided flyback output voltage is regulated to the 1.24V LMV431 internal reference. Note the additional soft-start circuit using C34, D13, and D14.
The compensator transfer function is defined:

$$G_{\text{COMP}}(s) = \frac{1 + \frac{s}{\omega_{Z1}}}{\frac{s}{\omega_{P2}} \times \left(1 + \frac{s}{\omega_{P3}}\right)}$$  \hspace{1cm} \text{(28)}

Where the secondary compensator pole is defined:

$$\omega_{P2} = \frac{1}{R72 \times C35}$$  \hspace{1cm} \text{(29)}

And the compensator zero is defined:

$$\omega_{Z1} = \frac{1}{R77 \times C35}$$  \hspace{1cm} \text{(30)}

And the primary roll-off pole is defined:

$$\omega_{P3} = \frac{1}{5 \times 5k\Omega \times C24}$$  \hspace{1cm} \text{(31)}

The resulting control loop gain is

$$T(s) = G_{\text{COMP}}(s) \times G_{3450} \times G_{V_C}(s) \times H_{FB}$$  \hspace{1cm} \text{(32)}

The compensator design for this system can be complicated; however with some useful assumptions, it can be simplified. Looking at the total DC gain ($G_{3450} \times G_{C0} \times H_{FB}$), the following can be made relatively constant over all designs:

- $R70 = 2k\Omega$, the 5kΩ internal pull-up, and the 0.55 multiplier gain.
- The opto CTR, though variable over temperature, given a fixed supply rail and a fixed R70 value.

In several cases, the product of two DC gain terms can also be identified as relatively constant over all designs if all of the previous LM3450A design methodology is observed:

- $V_{\text{inpk}}$ and $K_v$ are almost exactly inversely proportional (given $x$ remains constant when solving $V_{\text{DET}} = V_{\text{in}}/x$).
- $I_{p,pk}$ and $R30 || R31$ are closely inversely proportional (given current limit is a constant percentage above $I_{p,pk}$).

Given these relationships and following the complete LM3450A design method, the DC gain should only vary largely with change in output voltage (directly proportional).

The output pole of the converter on the other hand follows these basic relationships:
• $P_{\text{OUT-MAX}}$ and $C_{11}$ are exactly directly proportional given a constant output ripple specification, therefore there is no relative change to $\omega_{p1}$.
• $V_{\text{OUT}}$ is exactly inversely proportional to $\omega_{p1}$ given a constant output ripple specification.

With the opposing conditions of the output pole moving inversely proportional to $V_{\text{OUT}}$ and the DC gain moving proportional to $V_{\text{OUT}}$, the net result gives a very consistent uncompensated loop gain. Because of this, the exact compensator on this evaluation board can be a starting point for any LM3450A design.

During prototyping, if stability becomes a concern, the R77 value can be changed to improve stability. In general the compensator calculated in the Design Calculations section is sized to be stable and have a bandwidth of around 50-60Hz. This is a fairly high bandwidth for a PFC converter which will cause there to be some 120Hz ripple on COMP. This will decrease PF but improve transient response which is very helpful in phase dimmable applications.

Since it is usually desirable to maximize bandwidth (within the PFC limitation), there is a simple method to adjust the R77 value. Measure the twice-line frequency ripple on COMP. If the ripple is less than 200-300mV, increase R77 until it is within that range. If the ripple is larger, then decrease R77 until it is within that range. This will result in a very small PFC degradation, while maximizing bandwidth of the control loop.

### 9.9 STARTUP

When using the LM3450A with a phase dimmer, startup can be very disruptive. Any time the dimmer is turned on (via a separate switch or some state where the dimmer has been previously disconnected from its load), the LM3450A will attempt to bring the system to regulation. Because phase dimmers can be turned on and off quickly, the system capacitances may or may not be fully discharged, this can lead to a large variance in startup conditions. The best way to control startup transients is to soft start the dimming command and the PFC control simultaneously. This can be accomplished with the circuit shown in Figure 20. D20 is a dual common cathode schottky with very low forward voltage to allow COMP and VADJ to be pulled as close to zero as possible. The soft start time constant is set by C12 and R20. Q4, R21, and D21 form a reset circuit for C12. Since BIAS transitions to 20V whenever VCC hits the falling UVLO threshold and D21 is an 18V Zener, the base of Q4 will go high turning on Q4 and immediately resetting the capacitor to 0V. Then when VCC reaches the UVLO rising threshold and BIAS transitions to 14V, Q4 turns off and soft start is active again.

![Figure 20. Primary Soft-start Circuit](image)

**Figure 20. Primary Soft-start Circuit**

### Relevant Definitions

- $G_{VC}(s)$ – Converter Control-to-Output Transfer Function
- $G_{CO}$ – Converter Control-to-Output DC Gain
- $G_{3450}$ – LM3450A and External Gains
- $G_{\text{COMP}}(s)$ – Compensator Transfer Function
- $H_{FB}$ – Feedback Gain
- $\omega_{p1}$ – Converter Output Pole
- $\omega_{ps}$ – Compensator Secondary Integrator Pole
Design Information

\[ \omega_{Z_1} \] – Compensator Secondary Zero  
\[ \omega_{P_3} \] – Compensator Primary HF Pole  
\( T(s) \) – Total Loop Gain

Figure 21. Input EMI Filter

9.10 Input Filter

Background

Since the LM3450A is used for AC to DC systems, electromagnetic interference (EMI) filtering is critical to pass the necessary standards for both conducted and radiated EMI. This filter will vary depending on the output power, the switching frequencies, and the layout of the PCB. There are two major components to EMI: differential noise and common-mode noise. Differential noise is typically represented in the EMI spectrum below approximately 500kHz while common-mode noise shows up at higher frequencies.

Conducted

Figure 21 shows a typical filter used with an LM3450A design. To conform to conducted standards, a fourth order filter (two second order stages) is implemented using shielded inductors (L1, L2, L4), an EMI suppression X1/X2 film capacitor (C7), and a pulse-rated film capacitor (C1) which is also the primary PFC capacitor sized previously. In addition to the basic filter components, damping is used to prevent excitation of the resonant frequencies of the filter itself. The best practice for damping an EMI filter is to use an RC damper network across each filter capacitor. The C of the damper should be set to be 3 times the filter capacitor value. This EMI filter, if sized properly, can provide ample attenuation of the switching frequency and lower order harmonics contributing to differential noise. The filter can be described as follows:

- Stage 1 pole: L1+L4 and C7 gives 40db/decade roll-off
  - Stage 1 damping: C8||C9||C30 and R8||R9||R56
- Stage 2 pole: L2 and C1 gives 40db/decade roll-off
  - Stage 2 damping: C2||C3||C66 and R2||R3||R47

Since L1 and L4 are symmetrically placed in both the line and neutral legs of the AC line, they help to reduce common-mode noise also. It is sometimes necessary to place a high value resistance (R48, R51, R62) across each inductor to prevent excitation of the SRF of the inductor which is usually at higher frequencies. A Y1/Y2 film capacitor (C26) from the primary ground to the secondary ground is also commonly used for reduction of common mode noise.

Radiated

Conforming to radiated EMI standards is much more difficult and is dependent on the entire system including the enclosure. C26 will greatly help reduce radiated EMI; however, reduction of dV/dt on switching edges and PCB layout iterations are frequently necessary as well. Consult available literature and/or an EMI specialist for help with this. It can be a daunting task.
Interaction with Dimmers

In general, input filters and forward phase dimmers do not work well together. The triac needs a minimum amount of holding current to function. The converter itself is demanding a certain amount of current from the input to provide to its output. With no filter, the difference of the necessary hold current and the converter current is provided by the LM3450A dynamic hold circuit. Unfortunately, the actual dimmer current is not being monitored; instead a filtered version is being measured. In reality, the input filter is providing or taking current depending upon the dV/dt of the capacitors. The discrepancy between the measured input current at ISEN and the actual input current through the triac is the worst at the highest dV/dt of the input filter capacitors. The best way to deal with this problem is to minimize filter capacitance and increase the regulated hold current until there is enough current to satisfy the dimmer and filter simultaneously.

Figure 21 shows one effective way to improve the dynamic hold functionality when using an EMI filter. The hold current path through the passFET is derived between the two filter stages. In this configuration, the measured input current has only one stage of filtering capacitance to contribute to the discrepancy between measured and actual input current. In addition, the damping network for the C7 capacitor is directly connected to the dynamic hold point of the rectified AC (passFET drain). This, combined with the filter stage between the passFET and the transformer, help attenuate any unwanted switching frequency coupling into the dynamic hold circuit.

This configuration also provides some extra filtering of the feedforward VAC signal, which is now derived at the same point as the dynamic hold. One important addition to this EMI filter is a back-to-back TVS clamp across L2. During transient conditions, if the L2 filter rings too much, the current will try to change directions. There is no continuous path for current at the passFET drain, therefore the voltage can rise uncontrolled and damage the passFET. A 20V back-to-back TVS is sufficient to provide this protection.

9.11 Inrush Limiting, Damping and Clamping

Clamp

In any flyback converter there exists large ringing (V_{RING}) on the Q3 drain, as shown in Figure 22. This is due to the rising edge of the Q3 drain after turn-off, which excites the resonance created by the leakage inductance of the transformer and output capacitance of Q3. A clamp circuit is necessary to prevent damage to Q3 from excessive voltage. The evaluation boards use a transil (TVS) clamp, shown in Figure 23.

Figure 22. Switch Node Ringing

Figure 23. Transil Clamp

When Q3 is on and the drain voltage is low, the blocking diode (D5) is reverse biased and the clamp is inactive. When the MosFET is turned off, the drain voltage rises past the nominal voltage (reflected voltage plus the input voltage). If it reaches the TVS clamp voltage + the input voltage, the clamp prevents any further rise. The TVS diode (D1) voltage is set to prevent the MosFET from exceeding its maximum rating:
This clamp method is fairly efficient and very simple compared to other commonly used methods. Note that if the ringing is large enough that the clamp activates, the ringing energy is radiated at higher frequencies. Depending on PCB layout, EMI filtering method, and other application specific items, the transil clamp can present problems conforming to radiated EMI standards.

If the transil clamp becomes problematic at higher frequencies, an RCD clamp can be used to dampen the ringing. Looking at the EMI Performance section, it is obvious that the evaluation board fails near 30MHz. This would indicate an RCD clamp is indeed necessary for this design. C29 and R49, shown on the Complete Evaluation Board Schematic can be populated as desired to improve the EMI signature. This will degrade efficiency some.

Inrush

With a forward phase dimmer, a very steep rising edge causes a large inrush current every cycle as shown in Figure 24. Series resistance (R39, R57) can be placed between the filter and the triac to limit the effect of this current on the converter. This will, of course, degrade efficiency but some inrush protection is also necessary in any AC system due to startup. The size of R39 and R57 are best found experimentally as they provide attenuation for the whole system.

The inrush spike excites resonance(s) of the input filter, which can cause the current to ring negative, as shown in Figure 24, thereby shutting off the triac. The RC damper of the first stage of the input filter should be increased to dampen the worst-case ringing energy due to this edge. This can require a significant increase in capacitance depending upon the dimmer tested (more than 10x the filter capacitance). The resistance is then experimentally changed to create a ringing waveform that is most contained. The objective is to prevent the input current ringing from crossing the minimum regulated holding current thereby preventing misfires.

![Figure 24. Inrush Current Spike](image-url)
\[ f_{SW,MIN} = 45\text{kHz} \]
\[ V_{IN} = 120\text{V}_{AC} \]
\[ V_{IN,MIN} = 90\text{V}_{AC} \]
\[ V_{IN,MAX} = 135\text{V}_{AC} \]
\[ I_{LED} = 700\text{mA} \]
\[ \Delta v_{OUT} = 2\text{V} \]
\[ \Delta v_{IN,PK} = 60\text{V} \]
\[ I_{P,PK,LIM} = 3\text{A} \]
\[ V_{T,DES,MAX} = 400\text{V} \]
\[ P_{OUT,MAX} = 30\text{W} \]
\[ D_{@IN,MAX,PK} = 0.5 \]
\[ V_{OUT} = 50\text{V} \]
\[ \eta = 0.9 \]

10.2 Preliminary Calculations

Maximum peak input voltage:
\[
V_{IN,PK,MAX} = 135\text{V} \times \sqrt{2} = 191\text{V}
\] (34)

Minimum peak input voltage:
\[
V_{IN,PK,MIN} = 90\text{V} \times \sqrt{2} = 127\text{V}
\] (35)

Maximum average input current:
\[
I_{IN,MAX} = \frac{30\text{W}}{0.9 \times 0.85 \times 90\text{V}} = 436\text{mA}
\] (36)

Maximum peak input current:
\[
I_{IN,PK,MAX} = 436\text{mA} \times \sqrt{2} = 617\text{mA}
\] (37)

Maximum peak primary current:
\[
I_{P,PK,MAX} = \frac{2 \times 617\text{mA}}{0.5} = 2.47\text{A}
\] (38)

10.3 Main Switching MOSFET

Maximum drain-to-source voltage:
\[
V_{T,MAX} = 191\text{V} + |1.5 \times 100\text{V}| = 341\text{V}
\] (39)

Maximum peak MosFET current:
\[
I_{T,PK,MAX} = 2.47\text{A}
\] (40)

Maximum RMS MosFET current:
\[
I_{T,RMS,MAX} = 2.47\text{A} \times \sqrt{\frac{0.5}{3}} = 1\text{A}
\] (41)

Maximum power dissipation:
\[
P_{T,MAX} = 1\text{A}^2 \times 1\text{\Omega} = 1\text{W}
\] (42)

Resulting component choice:
10.4 Re-Circulating DIODE
Maximum reverse blocking voltage:
\[ V_{RD-MAX} = 50V + \left( \frac{191V}{2} \right) = 145V \]  
(43)

Maximum peak diode current:
\[ I_{D-PK-MAX} = 2.47A \times 2 = 4.94A \]  
(44)

Maximum average diode current:
\[ I_{D-MAX} = 617mA \times 2 = 1.23A \]  
(45)

Maximum power dissipation:
\[ P_{D-MAX} = 1.23A \times 1V = 1.23W \]  
(46)

Resulting component choice:
D10 \rightarrow 200V, 2A, SMB x 2  
(48)

10.5 Current Sense
Sense resistor:
\[ R30 || R31 = \frac{1.5V}{3A} = 0.5\Omega \]  
(49)

Power dissipation:
\[ P_{R30||R31} = 1A^2 \times 0.5\Omega = 500mW \]  
(50)

Resulting component choice:
\[ R30 || R31 \rightarrow 1\Omega, 0.25W || 1\Omega, 0.25W \]  
(51)

10.6 Input Capacitance
Minimum capacitance:
\[ C1 = \frac{430\mu H \times 2.47A^2}{\left( 127V + \frac{60V}{2} \right)^2 - \left( 127V - \frac{60V}{2} \right)^2} = 172nF \]  
(52)

Voltage rating:
\[ V_{C1} = 191V \times 2 = 382V \]  
(53)

Resulting component choice:
\[ C1 \rightarrow 220 \text{ nF}, 400V \]  
(54)

10.7 Output Capacitance
Minimum capacitance:
\[ C11 = \frac{30W}{2 \times \pi \times 60Hz \times 50V \times 2V} = 796nF \]  
(55)

Voltage rating:
\[ V_{C11} = 50V \times 1.25 = 62.5V \]  
(56)

Resulting component choice:
10.8 Transformer

Maximum acceptable reflected voltage:
\[ V_{R,\text{MAX}} = \frac{2}{3} \times (400V - 191V) = 140V \]  
(58)

Primary to secondary turns ratio:
\[ n = \frac{140V}{50V} = 2.8, \text{ choose } 2 \]  
(59)

Actual reflected voltage:
\[ V_R = 2 \times 50V = 100V \]  
(60)

Primary to auxiliary turns ratio:
\[ n_A = \frac{50V}{12.5V} = 4 \]  
(61)

Transformer primary inductance:
\[ L_p = \frac{0.5^2 \times 90V}{2 \times 45kHz \times 617mA} = 405\mu H \]  
(62)

Number of primary turns:
\[ N_p = \sqrt{\frac{430\mu H}{160nH/\text{turns}^2}} = 52 \text{ turns} \]  
(63)

Number of secondary turns:
\[ N_s = \frac{52 \text{ turns}}{2} = 26 \text{ turns} \]  
(64)

Number of auxiliary turns:
\[ N_A = \frac{26 \text{ turns}}{4} = 6.5 \text{ turns, choose } 7 \]  
(65)

Maximum flux density:
\[ B_{\text{MAX}} = \frac{430\mu H \times 2.47A}{52 \times 52 \text{mm}^2} = 392\text{mT} \]  
(66)

Resulting component choice:

| \( N_p \rightarrow 52 \text{ turns} \) |
| \( N_s \rightarrow 26 \text{ turns} \) |
| \( N_A \rightarrow 7 \text{ turns} \) |

10.9 Transil Clamp

TVS clamp voltage:
\[ V_{\text{TVS-D1}} = \frac{3}{2} \times 100V = 150V \]  
(68)

Resulting component choice:

\[ D1 \rightarrow 150V \text{ TVS} \]  
(69)
10.10 Dynamic Hold

ISEN sense resistance:
\[ R_{34} || R_{36} = \frac{200\text{mV}}{70\text{mA}} = 2.86\Omega \]  
(70)

HOLD resistance:
\[ R_{12} || R_{14} || R_{15} = \frac{12V - 30\Omega \times 90\text{mA}}{90\text{mA}} = 103\Omega \]  
(71)

Resulting component choice:
\[ \begin{align*} 
  R_{12} &| R_{14} | R_{15} = 300\Omega || 300\Omega || 300\Omega \\
  R_{34} &| R_{36} = 5.62\Omega || 5.62\Omega 
\end{align*} \]  
(72)

10.11 Decoder Input

Resistor divider:
\[ R_{32} = \frac{356\text{mV} \times 1\text{M}\Omega}{35V - 356\text{mV}} = 10.3\text{k}\Omega \]  
(73)

Resulting component choice:
\[ \begin{align*} 
  R_{26} + R_{29} &\rightarrow 1\text{M}\Omega \\
  R_{32} &\rightarrow 10\text{k}\Omega 
\end{align*} \]  
(74)

10.12 Output Voltage Sense

Resistance:
\[ R_{81} = \frac{1.24V \times 105\text{k}\Omega}{50V - 1.24V} = 2.67\text{k}\Omega \]  
(75)

Resulting component choice:
\[ \begin{align*} 
  R_{81} &\rightarrow 2.67\text{k}\Omega \\
  R_{72} &\rightarrow 105\text{k}\Omega 
\end{align*} \]  
(76)

10.13 Loop Compensation

Converter output pole:
\[ \omega_{p1} = \frac{30W}{50V^2 \times 1\text{mF}} = 12\text{rad/sec} \]  
(77)

Converter DC gain:
\[ G_{c0} = \frac{50V}{2.47A} = 20.2\Omega \]  
(78)

LM3450A and external sensing DC gain:
\[ G_{3450} = \frac{5k\Omega \times 1 \times 0.01 \times 0.55 \times \frac{1}{V} \times 191V}{0.5\Omega \times 2k\Omega} = 5.25S \]  
(79)

Secondary compensator dominant pole:
\[ \omega_{p2} = \frac{1}{105k\Omega \times 10\mu F} = 0.952\text{rad/sec} \]  
(80)

Secondary compensator zero:
\[ \omega_{z2} = \frac{1}{30.1k\Omega \times 10\mu F} = 3.32\text{rad/sec} \]  
(81)
Primary roll-off pole:

\[ \omega_{p3} = \frac{1}{5k\Omega \times 1\mu F} = 200 \text{ rad/ sec} \]  

Resulting component choice:

- C35 → 10 \mu F
- C24 → 1 \mu F
- R77 → 30.1 k\Omega
Figure 25. Complete Evaluation Board Schematic
<table>
<thead>
<tr>
<th>Reference Designator</th>
<th>Part Value</th>
<th>Manufacturer</th>
<th>Part Number</th>
</tr>
</thead>
<tbody>
<tr>
<td>C1</td>
<td>CAP MPY 0.22 µF 400V RAD</td>
<td>WIMA</td>
<td>MKP10-2240020</td>
</tr>
<tr>
<td>C2, C3, C8, C9, C30, C66</td>
<td>CAP CER 0.22 µF 250V RAD</td>
<td>TDK</td>
<td>FK20X7R2E224K</td>
</tr>
<tr>
<td>C4, C44</td>
<td>CAP ELEC 220 µF 35V RAD</td>
<td>NICHICON</td>
<td>UHE1V221MPD</td>
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### Table 1. 120V Bill of Materials (continued)

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## Table 2. 230V Bill of Materials

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### Table 2. 230V Bill of Materials (continued)

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Figure 26. Top Copper and Silkscreen

Figure 27. Bottom Copper and Silkscreen
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